

STL40DN3LLH5

Dual N-channel 30 V, 0.016 Ω, 11 A

PowerFLAT™ (5x6) double island, STripFET™ V Power MOSFET

Preliminary data

Features

Туре	V _{DSS}	R _{DSo(n)}	I _D
STL40DN3LLH5	30 V	< 0.018 Ω	11 A ⁽¹⁾

- 1. The value is rated according R_{thi-pcb}
- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses



Switching applications

Description

This product utilizes the 5th generation of design rules of ST's proprietary STripFET™ technology. The lowest available R_{DS(on)}*Q_g, in this chip scale package, makes this device suitable for the most demanding DC-DC converter applications, where high power density is to be achieved.

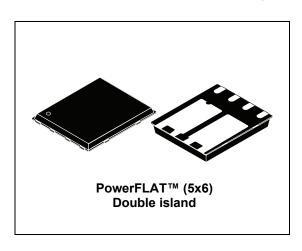


Figure 1. Internal schematic diagram

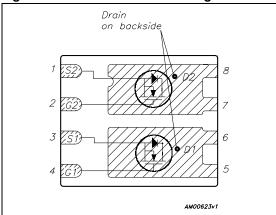


Table 1. Device summary

Order code	Marking	Package	Packaging
STL40DN3LLH5	40DN3LLH5	PowerFLAT™(5x6) Double island	Tape and reel

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STL40DN3LLH5 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{GS}	Gate-source voltage	± 22	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	40	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	26	Α
I _D ⁽²⁾	Drain current (continuous) at T _C = 25 °C	11	Α
I _D ⁽²⁾	Drain current (continuous) at T _C =100°C	7	Α
I _{DM} ⁽³⁾	Drain current (pulsed)	44	Α
P _{TOT} ⁽¹⁾	Total dissipation at T _C = 25°C	60	W
P _{TOT} (2)	Total dissipation at T _C = 25°C	4	W
	Derating factor	0.03	W/°C
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

^{1.} The value is rated according $R_{\text{thj-c}}$

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case (drain) (steady state)	2.08	°C/W
R _{thj-pcb} (1)	Thermal resistance junction-ambient	32	°C/W

^{1.} When mounted on FR-4 board of 1inch 2 , 2oz Cu, t < 10 sec

^{2.} The value is rated according $R_{\mbox{\scriptsize thj-pcb}}$

^{3.} Pulse width limited by safe operating area

Electrical characteristics STL40DN3LLH5

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	30			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating, V_{DS} = Max rating @125 °C			1 10	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ± 22 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.5		٧
R _{DS(on)}	Static drain-source on resistance	V_{GS} = 10 V, I_{D} = 5.5 A V_{GS} = 4.5 V, I_{D} = 5.5 A		0.016 0.02	0.018 0.025	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25 V, f=1 MHz, V _{GS} =0	-	475 97 19	-	pF pF pF
$egin{array}{c} Q_{ m g} \ Q_{ m gd} \end{array}$	Total gate charge Gate-source charge Gate-drain charge	V_{DD} =15 V, I_{D} = 11 A V_{GS} =4.5 V (see Figure 3)	-	4.5 1.7 1.9	-	nC nC nC

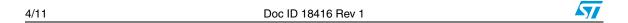


Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} =15 V, I_{D} = 11 A, R_{G} =4.7 Ω , V_{GS} =10 V (see Figure 2)	-	4 22 13 2.8	-	ns ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		11	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		44	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 11 A, V _{GS} =0	-		1.1	٧
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _{SD} = 11 A, di/dt = 100 A/μs, V _{DD} =25 V, Tj=150 °C	-	16.2 1 8.1		ns nC A

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration=300 μ s, duty cycle 1.5%

Test circuits STL40DN3LLH5

3 Test circuits

Figure 2. Switching times test circuit for resistive load

Figure 3. Gate charge test circuit

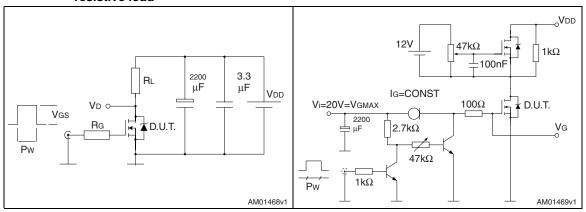


Figure 4. Test circuit for inductive load switching and diode recovery times

Figure 5. Unclamped inductive load test circuit

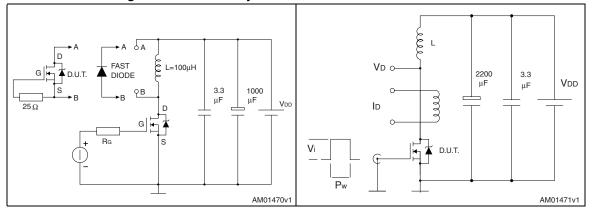
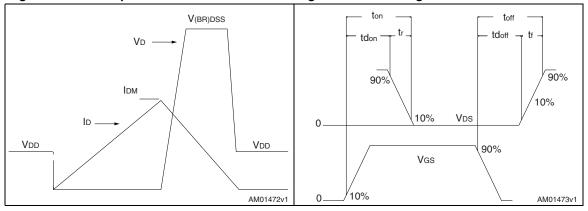


Figure 6. Unclamped inductive waveform

Figure 7. Switching time waveform



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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

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Table 8. PowerFLAT™ (5x6) double island mechanical data

Dim.		mm	
Diiii.	Min.	Тур.	Max.
Α	0.80	0.83	0.90
A1		0.02	0.05
A3		0.20	
b	0.35	0.40	0.47
D		5.00	
D1		4.75	
D2	4.11	4.21	4.31
Е		6.00	
E1		5.75	
E2	3.51	3.61	3.71
E3	2.32	2.42	2.52
е		1.27	
L	0.70	0.80	0.90
L1	0.48	0.58	0.68

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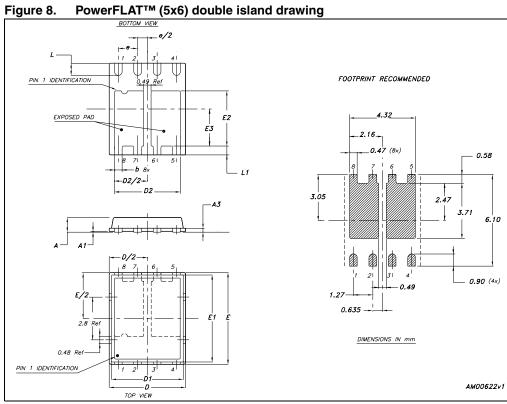


Figure 8.

Revision history STL40DN3LLH5

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
24-Jan-2011	1	First release

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